N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	60			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0016			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.0020			
I _D (A)	270			
Configuration	Single			

FEATURES

- Trench power MOSFET
- Package with low thermal resistance
- 100 % $\rm R_g$ and UIS tested

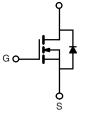


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Top View



D

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T	∫ _C = 25 °C, unles	s otherwise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C	- I _D -	270		
	T _C = 125 °C		120 ^a		
Continuous Source Current (Diode Conduction)		I _S	120 ^a	А	
Pulsed Drain Current ^b		I _{DM}	600		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	75		
Single Pulse Avalanche Energy	L = 0.1 MH	E _{AS}	281	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	PD	375	W	
	T _C = 125 °C	۲D	125	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	40	°C/W		
unction-to-Case (Drain)		R _{thJC}	0.4	0/10		

Notes

a. Package limited.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR4 material).



VBP1602



SPECIFICATIONS ($T_C = 25 \ ^{\circ}C$,		1		MIN.	r	-	1
PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static	- 1	-1			T	0	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS}=0~V,~I_{D}=250~\mu A$		60	-	-	v
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS}=V_{GS},\ I_{D}=250\ \mu A$		2.0	2.5	
Gate-Source Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V		-	-	± 100	nA
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	V _{DS} = 60 V	-	-	1	μA
	I _{DSS}	$V_{GS} = 0 V$	$V_{DS}=60~V,~T_J=125~^\circ C$	-	-	50	
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	1.5	mA
On-State Drain Current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	120	-	-	А
Drain-Source On-State Resistance ^a		$V_{GS} = 10 V$	I _D = 30 A	-	0.0016	-	Ω
	В	$V_{GS} = 10 V$	$I_D = 30 \text{ A}, \text{T}_\text{J} = 125 \ ^\circ\text{C}$	-	0.0031	-	
	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A, T _J = 175 °C	-	0.0037	-	
		$V_{GS} = 4.5 V$	I _D = 20 A	-	0.0020	-	
Forward Transconductance b	9 _{fs}	V _{DS} = 15 V, I _D = 30 A		-	164	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	12 060	15 100	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	5750	7200	
Reverse Transfer Capacitance	C _{rss}			-	860	1100	
Total Gate Charge ^c	Qg	V _{GS} = 10 V	V _{DS} = 30 V, I _D = 80 A	-	128	200	nC
Gate-Source Charge ^c	Q _{gs}			-	33	-	
Gate-Drain Charge ^c	Q _{gd}			-	11	-	
Gate Resistance	Rg	f = 1 MHz		0.8	1.68	2.6	Ω
Turn-On Delay Time ^c	t _{d(on)}	$V_{DD} = 30 \text{ V}, \text{ R}_{\text{L}} = 0.375 \ \Omega$ $\text{I}_{\text{D}} \cong 80 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \ \Omega$		-	20	25	- ns
Rise Time ^c	t _r			-	15	40	
Turn-Off Delay Time ^c	t _{d(off)}			-	65	100	
Fall Time ^c	t _f			-	12	20	
Source-Drain Diode Ratings and Chara	acteristics ^b				<u> </u>		
Pulsed Current ^a	I _{SM}			-	-	300	Α
Forward Voltage	V _{SD}	$I_{\rm F} = 80 {\rm A}, {\rm V_{GS}} = 0 {\rm V}$		-	0.88	1.5	V

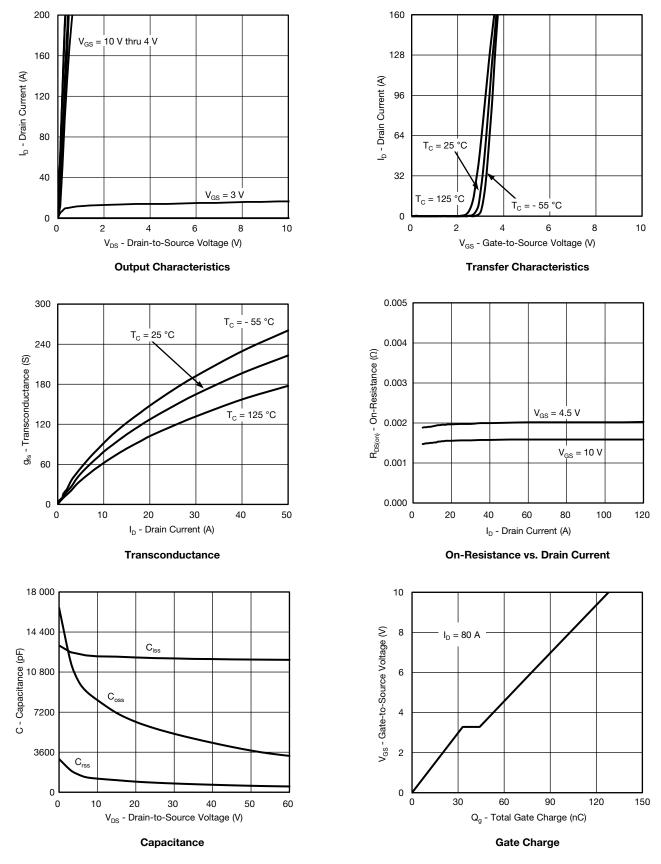
Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

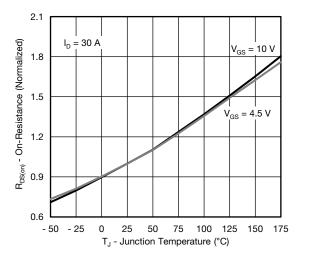


TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



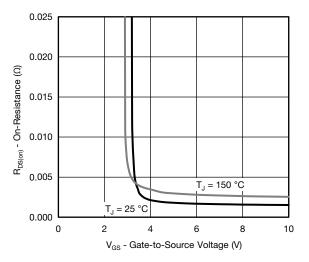
服务热线:400-655-8788



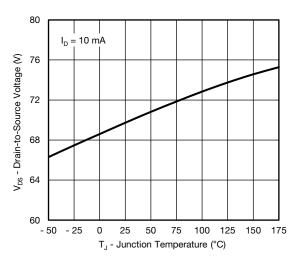


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

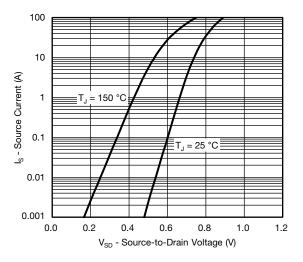




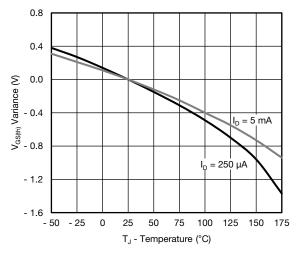
On-Resistance vs. Gate-to-Source Voltage



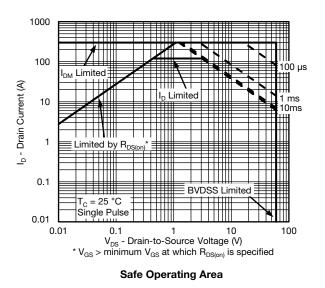
Drain Source Breakdown vs. Junction Temperature



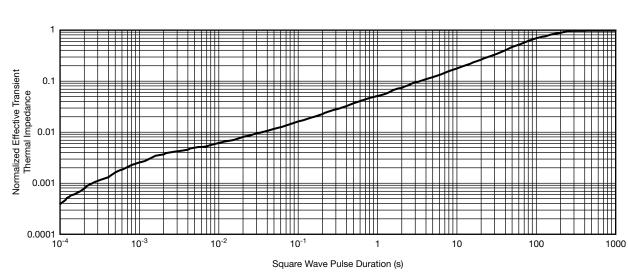
Source Drain Diode Forward Voltage



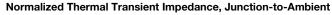


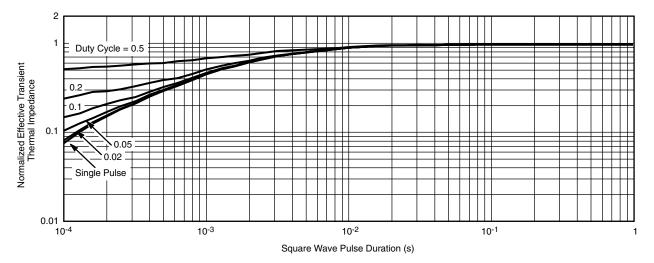






THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)







Note

• The characteristics shown in the two graphs

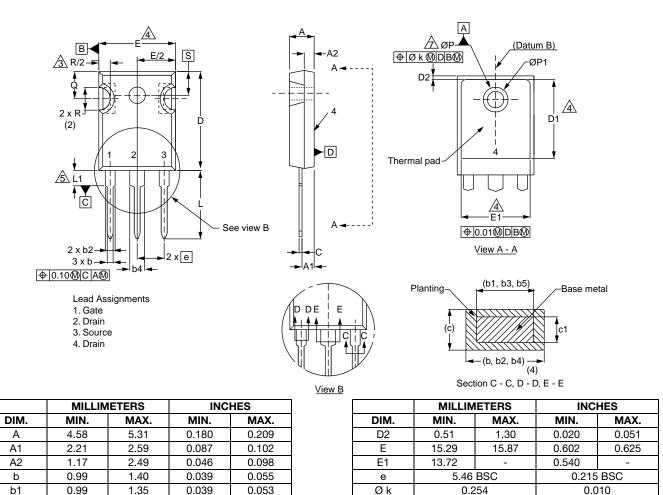
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



TO-247AC



L

L1

Ν

ØΡ

ØP1

Q

R

S

14.20

3.71

3.51

5.31

4.52

16.25

4.29

3.66

7.39

5.69

5.49

7.62 BSC

5.51 BSC

0.559

0.146

0.138

-

0.209

0.178

0.640

0.169

0.144

0.291

0.224

0.216

0.300 BSC

0.217 BSC

b2

b3

b4

b5

С

c1

D

D1

1.53

1.65

2.42

2.59

0.38

0.38

19.71

13.08

2.39

2.37

3.43

3.38

0.86

0.76

20.82

-

0.060

0.065

0.095

0.102

0.015

0.015

0.776

0.515

0.094

0.093

0.135

0.133

0.034

0.030

0.820

-



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